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# **PHOTODIODE**

# **BASED ON TYPE AE9493**

**ESCC Detail Specification No. 5403/001** 

Issue 1 November 2007





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### 1. GENERAL

### 1.1 SCOPE

This specification details the ratings, physical and electrical characteristics and test and inspection data for the component type variants and/or the range of components specified below. It supplements the requirements of, and shall be read in conjunction with, the ESCC Generic Specification listed under Applicable Documents.

### 1.2 APPLICABLE DOCUMENTS

The following documents form part of this specification and shall be read in conjunction with it:

- (a) ESCC Generic Specification No. 5000
- (b) MIL-STD-750, Test Methods and Procedures for Semiconductor Devices

## 1.3 TERMS, DEFINITIONS, ABBREVIATIONS, SYMBOLS AND UNITS

For the purpose of this specification, the terms, definitions, abbreviations, symbols and units specified in ESCC Basic Specification No. 21300 shall apply.

## 1.4 THE ESCC COMPONENT NUMBER AND COMPONENT TYPE VARIANTS

### 1.4.1 <u>The ESCC Component Number</u>

The ESCC Component Number shall be constituted as follows:

Example: 540300101

Detail Specification Reference: 5403001Component Type Variant Number: 01

## 1.4.2 <u>Component Type Variants</u>

The component type variants applicable to this specification are as follows:

Variant Number	Based on Type	Case	Lead/Terminal Material and Finish	Weight max g
01	AE9493	Metal Can	D7	1.1

The lead/terminal material and finish shall be in accordance with the requirements of ESCC Basic Specification No. 23500.

## 1.5 MAXIMUM RATINGS

The maximum ratings shall not be exceeded at any time during use or storage.

Maximum ratings shall only be exceeded during testing to the extent specified in this specification and when stipulated in Test Methods and Procedures of the ESCC Generic Specification.



Characteristics	Symbols	Maximum Ratings	Units	Remarks
Reverse Voltage	V <sub>R</sub>	-50	V	Over entire
Forward Current	I <sub>F</sub>	2	mA	operating temperature range
Junction Temperature	T <sub>j</sub>	+150	°C	-
Operating Temperature Range	T <sub>op</sub>	-45 to +110	°C	T <sub>case</sub>
Storage Temperature Range	T <sub>stg</sub>	-55 to +125	°C	-
Soldering Temperature	T <sub>sol</sub>	+295	°C	Note 1

## **NOTES:**

1. Duration 5 seconds maximum at a distance of not less than 5mm from the device body and the same lead shall not be resoldered until 3 minutes have elapsed.

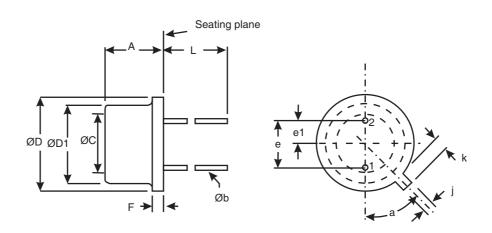
# 1.6 <u>HANDLING PRECAUTIONS</u>

These devices are susceptible to damage by electrostatic discharge. Therefore, suitable precautions shall be employed for protection during all phases of manufacture, testing, packaging, shipment and any handling.

These components are categorised as Class 3 per ESCC Basic Specification No. 23800 with a Minimum Critical Path Failure Voltage of 4000 Volts.

## 1.7 PHYSICAL DIMENSIONS AND TERMINAL IDENTIFICATION

# 1.7.1 <u>Metal Can Package - 2 lead</u>



Symbols	Dimensi	Notes	
Symbols	Min	Max	Notes
Α	5.05	5.45	
Øb	0.42	0.48	2

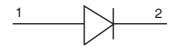


Symbols	Dimensio	Notes	
Symbols	Min	Max	Notes
ØC	5.75	5.85	3
ØD	9.05	9.35	
ØD1	8.03	8.23	
е	5.08		
e1	2.54	BSC	
F	0.45	0.7	
j	0.75	0.85	
k	0.8	0.93	4
L	12.7	-	2
а	45° E	5	

#### NOTES

- 1. Terminal identification is specified by reference to the tab position where lead 1 = Anode, lead 2 = Cathode.
- 2. Applies to all leads.
- 3. Glass window diameter.
- 4. Measured from the maximum diameter of the actual device.
- 5. Tab centreline.

# 1.8 FUNCTIONAL DIAGRAM



- 1. Anode
- 2. Cathode

### **NOTES:**

1. The cathode is internally connected to the case.

# 1.9 <u>MATERIALS AND FINISHES</u>

Materials and finishes shall be as follows:

a) Case

For the metal can package the case shall be hermetically sealed and have a metal body with a hard glass seal and a borosilicate glass window.

b) Leads/Terminals

As specified in Component Type Variants.



### 2. REQUIREMENTS

#### 2.1 GENERAL

The complete requirements for procurement of the components specified herein are as stated in this specification and the ESCC Generic Specification. Permitted deviations from the Generic Specification, applicable to this specification only, are listed below.

Permitted deviations from the Generic Specification and this Detail Specification, formally agreed with specific Manufacturers on the basis that the alternative requirements are equivalent to the ESCC requirement and do not affect the component's reliability, are listed in the appendices attached to this specification.

### 2.1.1 Deviations from the Generic Specification

### 2.1.1.1 Deviations from Screening Tests - Chart F3

(a) Power Burn-in and the subsequent Final Measurements for Power Burn-in shall be omitted.

### 2.2 MARKING

The marking shall be in accordance with the requirements of ESCC Basic Specification No. 21700 and as follows

The information to be marked on the component shall be:

- (a) The ESCC qualified components symbol (for ESCC qualified components only).
- (b) The ESCC Component Number.
- (c) Traceability information.

# 2.3 <u>TERMINAL STRENGTH</u>

The test conditions for terminal strength, tested as specified in the ESCC Generic Specification, shall be as follows:

Test Condition: E, lead fatigue.

# 2.4 <u>ELECTRICAL MEASUREMENTS AT ROOM, HIGH AND LOW TEMPERATURES</u>

Electrical measurements shall be performed at room, high and low temperatures.

### 2.4.1 Room Temperature Electrical Measurements

The measurements shall be performed at  $T_{amb}$ =+22 ±3 $^{\circ}$ C.

Characteristics	Characteristics Symbols MIL-STD-750 Test Conditions Test Method (Note 1)			Lin	Units	
			Min	Max		
Breakdown Voltage	V <sub>B</sub>	4021	I <sub>R</sub> = 10μA	50	-	V
Dark Current	I <sub>D</sub>	-	V <sub>R</sub> =-5V	-	300	pА
Forward Voltage	V <sub>F</sub>	4011	I <sub>F</sub> =1mA	550	650	mV
Shunt Capacitance	C <sub>SH</sub>	-	V=0V	380	450	pF

Characteristics		Test Conditions	Limits		Units	
	Test Method (Note 1)		(Note 1)	Min	Max	
Responsivity	R <sub>410</sub>	-	λ=410nm	150	-	mA/W
	R <sub>500</sub>		λ=500nm	220	-	
	R <sub>600</sub>		λ=600nm	300	-	
	R <sub>750</sub>		λ=750nm	450	-	
	R <sub>800</sub>		λ=800nm	480	-	
Field of View	FOV	-		40.4	-	0
			(Note 2)			

# NOTES:

- 1. Unless otherwise specified  $V_R = 0V$ , load resistance =  $50 \pm 1\Omega$ . 2. Guaranteed but not tested.

#### High and Low Temperatures Electrical Measurements 2.4.2

Characteristics	Symbols	MIL-STD-750	Test Conditions	Limits		Units
		Test Method	(Notes 1, 2)	Min	Max	
Breakdown Voltage	V <sub>B</sub>	4021	$T_{case}$ =+110(+0-5)°C $I_R$ = 10 $\mu$ A	50	-	V
			$T_{case}$ =-45(+5-0)°C $I_R$ = 10 $\mu$ A	50	-	
Dark Current	I <sub>D</sub>	-	T <sub>case</sub> =+110(+0-5)°C V <sub>R</sub> =-5V	-	4	nA
			T <sub>case</sub> =-45(+5-0)°C V <sub>R</sub> =-5V	-	0.3	
Forward Voltage	V <sub>F</sub>	4011	T <sub>case</sub> =+110(+0-5)°C I <sub>F</sub> =1mA	-	550	mV
			T <sub>case</sub> =-45(+5-0)°C I <sub>F</sub> =1mA	-	800	



Characteristics	Symbols MIL-STD-750		Test Conditions	Limits		Units
Test Metho		Test Method	(Notes 1, 2)	Min	Max	
Responsivity		-	T <sub>case</sub> =+110(+0-5)°C			mA/W
	R <sub>410</sub>		λ=410nm	150	-	
	R <sub>500</sub>		λ=500nm	220	-	
	R <sub>600</sub>		λ=600nm	300	-	
	R <sub>750</sub>		λ=750nm	450	-	
	R <sub>800</sub>		λ=800nm	480	-	
		-	T <sub>case</sub> =-45(+5-0)°C			mA/W
	R <sub>410</sub>		λ=410nm	150	-	
	R <sub>500</sub>		λ=500nm	220	-	
	R <sub>600</sub>		λ=600nm	300	-	
	R <sub>750</sub>		λ=750nm	450	-	
	R <sub>800</sub>		λ=800nm	430	-	

## **NOTES:**

- 1. Read and record measurements shall be performed on a sample of 5 components with 0 failures allowed. Alternatively a 100% inspection may be performed.
- 2. Unless otherwise specified  $V_R$ =0V, load resistance = 50  $\pm$  1 $\Omega$ .

# 2.5 PARAMETER DRIFT VALUES

Unless otherwise specified, the measurements shall be performed at  $T_{amb}$ =+22  $\pm 3^{o}$ C.

The test methods and test conditions shall be as per the corresponding test defined in Room Temperature Electrical Measurements.

The drift values ( $\Delta$ ) shall not be exceeded for each characteristic specified. The corresponding absolute limit values for each characteristic shall not be exceeded.

Characteristics	Symbols		Units		
		Drift	Absolute		
		Value Δ	Min	Max	
Shunt Capacitance	C <sub>SH</sub>	±10%	380	450	pF
Responsitivity	R <sub>410</sub>	±6%	150	-	mA/W
	R <sub>500</sub>	±6%	220	-	
	R <sub>600</sub>	±6%	300	-	
	R <sub>750</sub>	±6%	450	-	
	R <sub>800</sub>	±6%	480	-	

# 2.6 <u>INTERMEDIATE AND END-POINT ELECTRICAL MEASUREMENTS</u>

Unless otherwise specified, the measurements shall be performed at  $T_{amb}$ =+22 ±3 $^{o}$ C.

The test methods and test conditions shall be as per the corresponding test defined in Room Temperature Electrical Measurements.



The limit values for each characteristic shall not be exceeded.

Characteristics	Symbols	Limits		Units
		Min	Max	
Breakdown Voltage	V <sub>B</sub>	50	-	V
Dark Current	I <sub>D</sub>	-	300	pА
Forward Voltage	V <sub>F</sub>	550	650	mV
Shunt Capacitance (Note 1)	C <sub>SH</sub>	380	450	pF
Responsivity (Note 1)	R <sub>410</sub>	150	-	mA/W
	R <sub>500</sub>	220	-	
	R <sub>600</sub>	300	-	
	R <sub>750</sub>	450	-	
	R <sub>800</sub>	480	-	

# **NOTES:**

1. Test may be omitted during Operating Life intermediate electrical measurements at the 1000 hour data point.

# 2.7 <u>HIGH TEMPERATURE REVERSE BIAS BURN-IN CONDITIONS</u>

Characteristics	Symbols	Test Conditions	Units
Ambient Temperature	T <sub>amb</sub>	+125(+0-5)	°C
Reverse Voltage	V <sub>R</sub>	-10	V
Duration	-	168 minimum	hours

## **NOTES:**

1. Load resistance =  $50 \pm 1\Omega$ .

# 2.8 <u>OPERATING LIFE CONDITIONS</u>

Characteristics	Symbols	Test Conditions	Units
Ambient Temperature	T <sub>amb</sub>	+125(+0-5)	°C
Reverse Voltage	V <sub>R</sub>	-2.5	V

# NOTES:

1. Load resistance =  $50 \pm 1\Omega$ .



# **APPENDIX 'A'**

# AGREED DEVIATIONS FOR OSI OPTOELECTRONICS AS (N)

ITEMS AFFECTED	DESCRIPTION OF DEVIATIONS
Deviations from Production Control- Chart F2	Special In-process Control Internal Visual Inspection. The criteria specified for 75% minimum die mounting material around the visible die perimeter for die mounting defects may be omitted.